

Main page > Repair Equipment > Tools and equipment > Handles / feeders > Professional TFIX OP3 BGA Recovery Platform



Professional TFIX OP3 BGA Recovery Platform

Product ID: 21871

Price: **59.00 EUR**

Product weight: **1.00 kg**

Description:

Professional TFIX OP3 BGA Recovery Platform is service platform for repairing smaller printed circuit boards such as cell phones and many other devices. Made of anodized aluminum with a steel base, it has two handles to securely secure the serviced PCB and a snap-in system with an additional spring provides the right pressure. The large, ground-insulated stand provides stability. Material from which it is made is resistant to overheating during service work, eg using hotair. This model also has a built-in positioners for iPhone systems for cleaning and preparation before reballing.

Contact details:

Telefon: +48 17 227 00 25
Infolinia: 0 801 671 717
E-mail: biuro@multi-com.pl
Skype: Multi-COM

Address:

Multi-COM Sp. z o.o.
ul. Stanisława Krzaklewskiego 31b
36-100 Kolbuszowa
POLSKA

[Go to the product](#)

